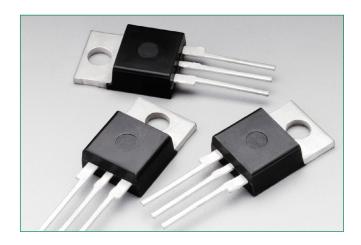
Silicon Controlled Rectifiers





Additional Information







Accessories



Samples

Description

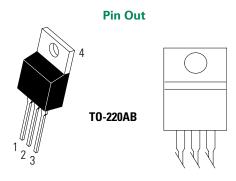
Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 25 Amperes RMS
- High Surge Current Capability300 Amperes
- Rugged Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT, and IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum at 125°C
- These are Pb-Free Devices

Functional Diagram





Silicon Controlled Rectifiers

Maximum Ratings (TJ = 25°C unless otherwise noted)

Rating		Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (- 40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open)	MCR25DG MCR25MG MCR25NG	V _{DRM} , V _{RRM}	400 600 800	V
On-State RMS Current (180° Conduction Angles; $T_c = 80$ °C)		I _{T (RMS)}	25	А
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 125$ °C)		I _{TSM}	300	А
Circuit Fusing Consideration (t = 8.3 ms)		l²t	373	A²sec
Forward Peak Gate Power (Pulse Width \leq 1.0 μ sec, T_{c} = 80°C)		P _{GM}	20.0	W
Forward Average Gate Power (t = 8.3 msec, $T_c = 80$ °C)	P _{GM (AV)}	0.5	W	
Forward Peak Gate Current (Pulse Width $\leq 1.0 \mu sec$, $T_c = 80^{\circ}C$	I _{GM}	2.0	А	
Operating Junction Temperature Range	T _J	-40 to 125	°C	
Storage Temperature Range		T _{stg}	-40 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance	Junction-to-Case (AC) Junction-to-Ambient	R _{8JC} R _{8JA}	1.5 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds		T_{\scriptscriptstyleL}	260	°C

Electrical Characteristics - OFF (T₁ = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current	$T_J = 25^{\circ}C$	I _{DRM} ,	-	-	0.01	mΛ
$(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM}, \text{ Gate Open})$	$T_J = 125^{\circ}C$	I _{RRM}	-	-	2.0	mA

Electrical Characteristics - ON (T₁ = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Forward On–State Voltage (Note 2) ($I_{TM} = 50 \text{ A}$)	V_{TM}	_	_	1.8	V
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}; R_L = 100 \Omega)$	I _{GT}	4.0	12	30	mA
Holding Current (Anode Voltage = 12 V, Initiating Current = 200 mA)	I _H	5.0	13	40	mA
Latch Current $(V_D = 12 \text{ V}, I_G = 30 \text{ mA})$	I _L	_	35	80	mA
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, R_L = 100 \Omega)$	V _{GT}	0.5	0.67	1.0	V

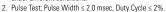
Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate of Rise of Off–State Voltage $(V_D = 67\% \text{ of Rated V}_{DRM}, \text{ Exponential Waveform, Gate Open, T}_J = 125°C)$	dv/dt	100	250	_	V/µs
Critical Rate of Rise of On-State Current (I _{nv} = 50 A, Pw = 30 µsec, diG/dt = 1 A/µsec, I _{nv} = 50 mA	di/dt	_	_	50	A/µs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance under different conditions.

Pulse Test; Pulse Width ≤ 2.0 msec, Duty Cycle ≤ 2%

may not be indicated by the Electrical Characteristics if operated





^{1.} V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I _H	Holding Current

Reverse Blocking Region (off state)

Reverse Avalanche Region
Anode –

Figure 1.Typical Gate Trigger Current vs Junction Temperature

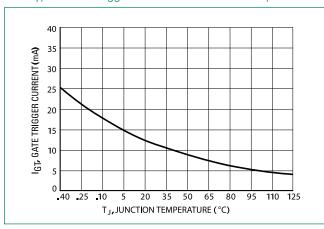


Figure 2.Typical Gate Trigger Voltage vs Junction Temperature

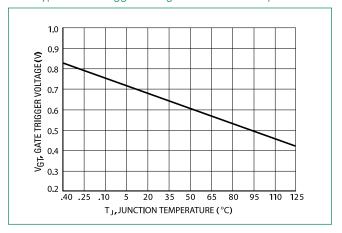


Figure 3.Typical On–State Characteristics

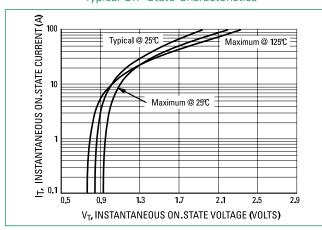
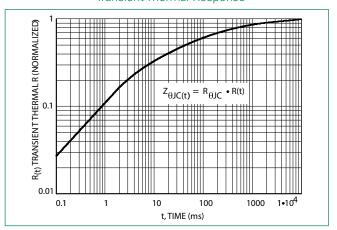


Figure 4.Transient Thermal Response



Silicon Controlled Rectifiers

Figure 7.Typical RMS Current Derating

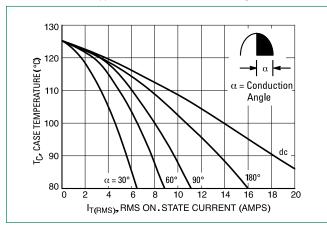


Figure 8.On State Power Dissipation

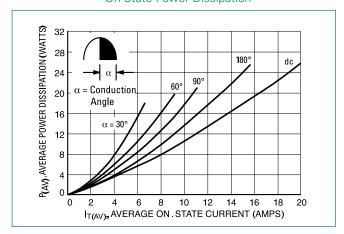


Figure 9.Typical Exponential Static dv/dt Versus Peak Voltage

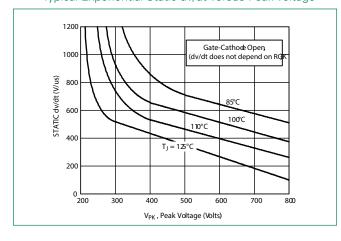


Figure 10.
Typical Exponential Static dv/dt Vs Junction Temperature

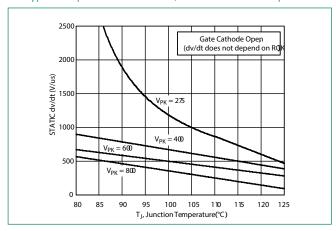
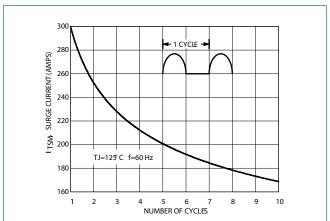


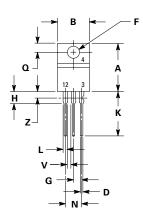
Figure 11.Maximum Non–Repetitive Surge Current

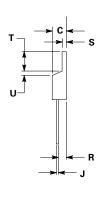




Silicon Controlled Rectifiers

Dimensions





1,2	Cas	-220AB le 221A tyle 3	YMAXX MCR28xG AKA
2 3	Y M A AKA G	=Year =Month =Assembly Site =Diode Polarity =Pb-Free Package	

Part Marking System

Dim	Inches		Millim	neters
Dim	Min	Max	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
K	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at http://www.littelfuse.com/disclaimer-electronics.

Pin Assignment			
1	Cathode		
2	Anode		
3	Gate		
4	Anode		

Ordering Information

Device	Package	Shipping
MCR25DG	TO 0004D	
MCR25MG	TO-220AB (Pb-Free)	1000 Units / Box
MCR25NG	(1 b-1100)	



Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are

^{1.} Dimensioning and tolerancing per ansi y14.5m, 1982.

Controlling dimension: inch.
 Dimension z defines a zone where all body and lead irregularities are allowed.

单击下面可查看定价,库存,交付和生命周期等信息

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